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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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## Silicon NPN Phototransistor Version 1.3

### **SFH 300**



#### Features:

• Spectral range of sensitivity: (typ) 450 ... 1100 nm

• Package: 5mm Radial (T 1 ¾), Epoxy

Special: High linearity

· Available in groups

### **Applications**

Photointerrupters

Industrial electronics

· For control and drive circuits

· Computer-controlled flashes

### **Ordering Information**

Туре:	Photocurrent	Ordering Code
	I <sub>PCE</sub> [μA]	
	$\lambda = 950 \text{ nm}, E_e = 0.5 \text{ mW/cm}^2,$	
	V <sub>CE</sub> = 5 V	
SFH 300	≥ 630	Q62702P1189
SFH 300-3/4	≥ 1000	Q62702P3586

Note: Only one bin within one packing unit (variation less than 2:1)



# $\underline{\text{Maximum Ratings } (T_A = 25 \, ^{\circ}\text{C})}$

Parameter	Symbol	Values	Unit
Operating and storage temperature range	T <sub>op</sub> ; T <sub>stg</sub>	-40 100	°C
Collector-emitter voltage	V <sub>CE</sub>	35	V
Collector current	I <sub>C</sub>	50	mA
Collector surge current (τ < 10 μs)	I <sub>CS</sub>	100	mA
Emitter-collector voltage	V <sub>EC</sub>	7	V
Total Power dissipation	P <sub>tot</sub>	200	mW
Thermal resistance	R <sub>thJA</sub>	375	K/W
ESD withstand voltage (acc. to ANSI/ ESDA/ JEDEC JS-001 - HBM)	V <sub>ESD</sub>	2000	V

# Characteristics ( $T_A = 25 \, ^{\circ}C$ )

Parameter		Symbol	Values	Unit
Wavelength of max. sensitivity	(typ)	λ <sub>S max</sub>	880	nm
Spectral range of sensitivity	(typ)	λ <sub>10%</sub>	(typ) 450 1100	nm
Radiant sensitive area	(typ)	Α	0.11	mm <sup>2</sup>
Dimensions of chip area	(typ)	LxW	(typ) 0.55 x 0.55	mm x mm
Half angle	(typ)	φ	± 25	0
Capacitance $(V_{CE} = 0 \text{ V}, f = 1 \text{ MHz}, E = 0)$	(typ)	C <sub>CE</sub>	7.5	pF
Dark current (V <sub>CE</sub> = 20 V, E = 0)	(typ (max))	I <sub>CE0</sub>	1 (≤ 50)	nA
Rise and fall time $(I_C = 1 \text{ mA}, V_{CC} = 5 \text{ V}, R_L = 1 \text{ k}\Omega)$	(typ)	t <sub>r</sub> , t <sub>f</sub>	10	μs



## **Grouping** (T<sub>A</sub> = 25 °C, $\lambda$ = 950 nm)

Group	Min Photocurrent	Max Photocurrent	Typ Photocurrent	Rise and fall time
		$E_e = 0.5 \text{ mW/cm}^2,$ $V_{CE} = 5 \text{ V}$	SFH 300: E <sub>V</sub> = 1000 lx, Std. Light A, V <sub>CE</sub> = 5 V	$I_C = 1 \text{ mA}, V_{CC} = 5$ V, $R_L = 1 \text{ k}\Omega$
	I <sub>PCE, min</sub> [μA]	I <sub>PCE, max</sub> [μΑ]	I <sub>PCE</sub> [μΑ]	t <sub>r</sub> , t <sub>f</sub> [μs]
-2	630	1250	3000	7.5
-3	1000	2000	4800	10
-4	1600		7700	10

Group	Collector-emitter saturation voltage
	$I_C = I_{PCEmin} \times 0.3, E_e = 0.5 \text{ mW/cm}^2$
	V <sub>CEsat</sub> [mV]
-2	130
-3	140
-4	150

Note.:  $I_{PCEmin}$  is the min. photocurrent of the specified group.

## Relative Spectral Sensitivity 1) page 8

$$S_{rel} = f(\lambda)$$

100

 $S_{rel}$ 

80

70

60

40

30

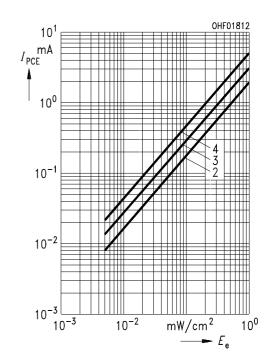
20

10

400 500 600 700 800 900 nm 1100

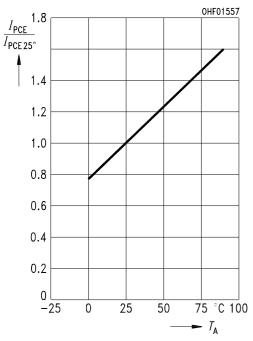
## Photocurrent 1) page 8

$$I_{PCE} = f(E_e), V_{CE} = 5 V$$



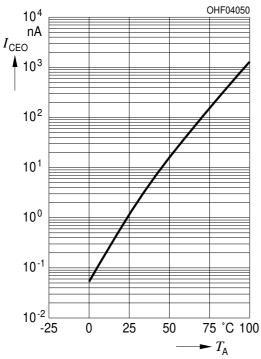
### Photocurrent 1) page 8

 $I_{PCE}$  /  $I_{PCE}(25^{\circ}C) = f(T_{A})$ ,  $V_{CE} = 5 \text{ V}$ 



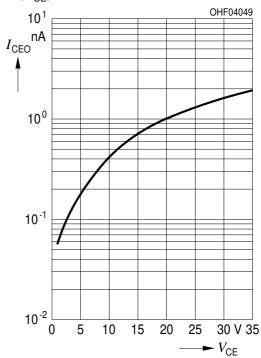
## Dark Current 1) page 8

$$I_{CEO} = f(T_A), E = 0$$



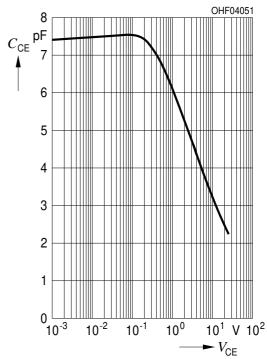
## Dark Current 1) page 8

$$I_{CEO} = f(V_{CE}), E = 0$$



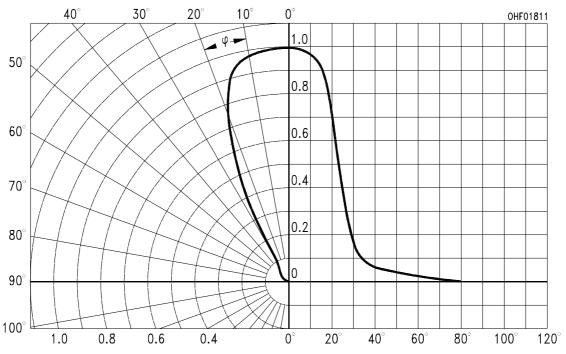
# Collector-Emitter Capacitance 1) page 8

$$C_{CE} = f(V_{CE}), f = 1 MHz, E = 0$$

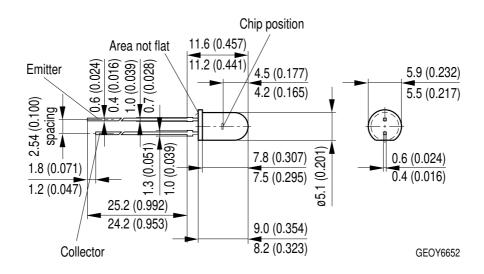


## **Directional Characteristics** 1) page 8

$$S_{rel} = f(\phi)$$



### **Package Outline**



Dimensions in mm (inch).

### **Package**

5mm Radial (T 1 ¾), Epoxy

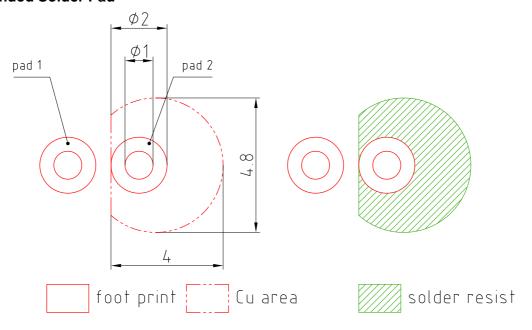
### **Approximate Weight:**

0.3 g

### Note

Packing information is available on the internet (online product catalog).

### **Recommended Solder Pad**

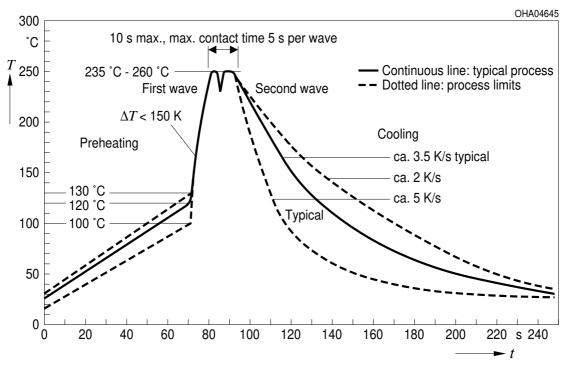


E062.3010.188-01

Dimensions in mm.

### **TTW Soldering**

IEC-61760-1 TTW



#### **Disclaimer**

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

#### Attention please!

The information describes the type of component and shall not be considered as assured characteristics.

Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version in the Internet.

#### **Packing**

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Components used in life-support devices or systems must be expressly authorized for such purpose!

Critical components\* may only be used in life-support devices\*\* or systems with the express written approval of OSBAM OS

- \*) A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or the effectiveness of that device or system.
- \*\*) Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health and the life of the user may be endangered.



### Glossary

Typical Values: Due to the special conditions of the manufacturing processes of LED, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.



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